Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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PRELIMINARY DATA SHEET

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LASER DIODE

1 550 nm FOR LONG HAUL 2.5 Gb/s InGaAsP MQW-DFB LASER DIODE TOSA

DESCRIPTION

The NX8511UD is a 1 550 nm Multiple Quantum Well (MQW) structured Distributed Feed-Back (DFB) laser diode TOSA (transmitter optical subassembly) with InGaAs monitor PIN-PD in a receptacle type package designed for SFF/SFP transceiver with LC duplex receptacle.

This device is ideal for Synchronous Digital Hierarchy (SDH) system, long haul STM-16 (L-16.2), ITU-T recommendations, and SONET OC-48 (LR-2).



FEATURES

- Peak emission wavelength
- Optical output power
- Wide operating temperature range
 - SMSR = 40 dB

 $\lambda_p = 1550 \text{ nm}$ Pf = 2.0 mW

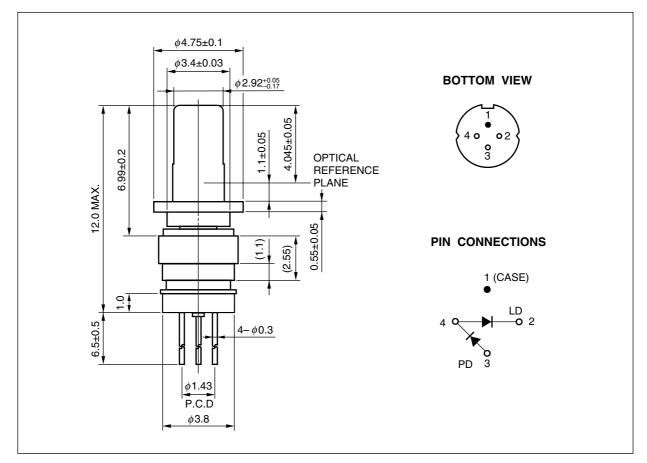
Tc = -20 to +85°C

- InGaAs monitor PIN-PD
- Internal optical isolator
- Based on Telcordia reliability

· Side mode suppression ratio

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PACKAGE DIMENSIONS (UNIT: mm)



ORDERING INFORMATION

Part Number	Package	Pin Connections
NX8511UD	φ3.8 mm TOSA	

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit
Optical Output Power from Fiber	Pf	5.0	mW
Forward Current of LD	lf	150	mA
Reverse Voltage of LD	VR	2.0	V
Forward Current of PD	lf	2.0	mA
Reverse Voltage of PD	VR	15	V
Operating Case Temperature	Tc	–20 to +85	°C
Storage Temperature	Tstg	–40 to +85	°C
Lead Soldering Temperature	Tsld	350 (3 sec.)	°C
Relative Humidity (noncondensing)	RH	85	%

ELECTRO-OPTICAL CHARACTERISTICS (Tc = -20 to +85°C, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Optical Output Power from Fiber	Pf	CW		2.0		mW
Operating Voltage	Vop	P _f = 2.0 mW		1.1	1.6	V
Threshold Current	Ith	Tc = 25°C		10	20	mA
					50	
Threshold Output Power	Pth	IF = Ith			100	μW
Differential Efficiency	$\eta_{ m d}$	$P_{f} = 2.0 \text{ mW}, \text{ Tc} = 25^{\circ}\text{C}$	0.07	0.1		W/A
		P _f = 2.0 mW	0.04			
Peak Emission Wavelength	λρ	CW, P _f = 2.0 mW	1 530	1 550	1 570	nm
Side Mode Suppression Ratio	SMSR	P _f = 2.0 mW	30	40		dB
Rise Time	tr	20-80%, $P_{pk} = 2.0 \text{ mW}$, $I_F = I_{th}$			100	ps
Fall Time	tr	80-20%, $P_{pk} = 2.0 \text{ mW}$, $I_F = I_{th}$			150	ps
Monitor Current	Im	$V_{R} = 1.5 V, P_{f} = 1.0 mW$	100	500	1 000	μA
Monitor Dark Current	lo	V _R = 1.5 V, T _c = 25°C		0.1	50	nA
		V _R = 1.5 V		10	500	
Tracking Error	γ	Im = const.	-1.0		1.0	dB
Connector Repeatability	_	With master pigtail	-1.0		1.0	dB

			Elec	tro-Optical	Character	istics			
Part Number	Absolute Max	imum Ratings	@Tc = 25°C		@Tc		Application	Deskage	
Part Number	Тс (°С)	T₅tg (°C)	lth (mA)	P _f (mW)		ւշ m)	Application	Package	
			TYP.	TYP.	MIN.	MAX.			
NX7312UA	-40 to +85	-40 to +85	8	0.2	1 274	1 356	156 Mb/s: STM-1 (S-1.1)	ϕ 3.8 mm TOSA	
							622 Mb/s: STM-4 (S-4.1)		
NX7313UA	-40 to +85	-40 to +85	8	0.6	1 270	1 355	1.25 Gb/s: GbE	ϕ 3.8 mm TOSA	
NX7314UA	-40 to +85	-40 to +85	8	1.0	1 263	1 360	156 Mb/s: STM-1 (L-1.1)	<i>∲</i> 3.8 mm TOSA	
NX7315UA	-40 to +85	-40 to +85	8	0.6	1 266	1 360	2.5 Gb/s: STM-16 (I-16)	<i>∲</i> 3.8 mm TOSA	

LD Ø3.8 mm FP-TOSA PACKAGES FAMILY FOR OPTICAL FIBER COMMUNICATIONS

LD Ø3.8 mm DFB-TOSA PACKAGES FAMILY FOR OPTICAL FIBER COMMUNICATIONS

			Elec	tro-Optical	Character	istics			
Part Number	Absolute Max	imum Ratings	@Tc = 25°C		@Tc		Application	Paakaga	
Fait Number	Тс (°С)	T₅tg (°C)	lth (mA)	P _f (mW)		 m)	Application	Package	
			TYP.	TYP.	MIN.	MAX.			
NX8310UA	-40 to +85	-40 to +85	10	2.0	1 280	1 335	622 Mb/s: STM-4 (L-4.1)	ϕ 3.8 mm TOSA	
NX8311UD	-20 to +85	-40 to +85	10	2.0	1 280	1 335	2.5 Gb/s: STM-16 (L-16.1)	<i>∲</i> 3.8 mm TOSA	
NX8312UA	-20 to +85	-40 to +85	10	1.0	1 280	1 335	2.5 Gb/s: STM-16 (S-16.1)	<i>∲</i> 3.8 mm TOSA	
NX8312UD	-20 to +85	-40 to +85	10	1.0	1 280	1 335	2.5 Gb/s: STM-16 (S-16.1)	<i>∲</i> 3.8 mm TOSA	
NX8510UD Series	0 to +70	-40 to +85	10	2.0	λ _P -3 ^{*1}	λ _p +3 ^{*1}	2.5 Gb/s: CWDM	ϕ 3.8 mm TOSA	
NX8511UD	-20 to +85	-40 to +85	10	2.0	1 530	1 570	2.5 Gb/s: STM-16 (L-16.2)	ϕ 3.8 mm TOSA	

*1 Available for CWDM Wavelengths based on ITU-T recommendations λ_p = 1 470, 1 490, 1 510, 1 530, 1 550, 1 570, 1 590, 1 610 nm

REFERENCE

Document Name	Document No.
OPTICAL SEMICONDUCTOR DEVICES FOR FIBEROPTIC COMMUNICATIONS SELECTION GUIDE	PL10161E
Opto-Electronics Devices Pamphlet	PX10160E

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 - "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

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M8E 00.4-0110

SAFETY INFORMATION ON THIS PRODUCT



SEMICONDUCTOR LASER		
AVOID EXPOSURE-Invisible		
Laser Radiation is emitted from		
this aperture		

Warning Laser Beam	 A laser beam is emitted from this diode during operation. The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight. Do not look directly into the laser beam. Avoid exposure to the laser beam, any reflected or collimated beam.
Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.

► For further information, please contact

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